Octal transceiver with direction pin (3-State)

74AC245
74ACT245

FEATURES

- 74ACT245 has TTL-compatible inputs
- 74AC245 has CMOS-compatible inputs
- 3-State outputs source/sink 24mA
- Non-inverting buffers, bidirectional data path
- Meets or exceeds JEDEC standard for 74AC(T)XX family
- Superior ground bounce noise immunity

DESCRIPTION

The 74AC245/74ACT245 is an octal transceiver featuring non-inverting 3-State bus compatible outputs in both send and receive directions. The '245' features an output enable ($\overline{OE}$) input for easy cascading and a send/receive (DIR) input for direction control. $\overline{OE}$ controls the outputs so that the buses are effectively isolated.

The '245' is functionally identical to the '640', but the '640' has true (non-inverting) outputs.

QUICK REFERENCE DATA

GND = 0V; T_{amb} = 25°C; $t_r = t_f \leq 2.5$ ns

SYMBOL	PARAMETER	CONDITIONS	TYPICAL			UNIT
			AC		ACT	
			V_{CC} = 3.3V	V_{CC} = 5.0V	V_{CC} = 5.0V	
t_{PHL}/t_{PLH}	Propagation delay An to Bn; Bn to An	C_L = 50pF	4.4	3.3	4.3	ns
C_I	Input capacitance		4.5			pF
C_{PD}	Power dissipation capacitance per transceiver	V_I = GND to V_{CC}[1] outputs enabled outputs disabled	31 5.5		30 4	pF

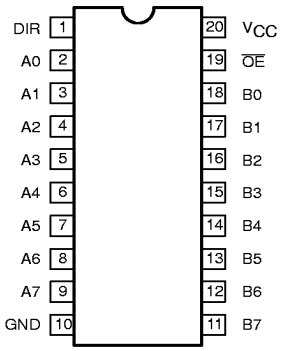
NOTES:

1. C_{PD} is used to determine the dynamic power dissipation (P_D in µW)
   $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:
   f_i = input frequency in MHz; C_L = output load capacity in pF;
   f_o = output frequency in MHz; V_{CC} = supply voltage in V;
   $\Sigma (C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

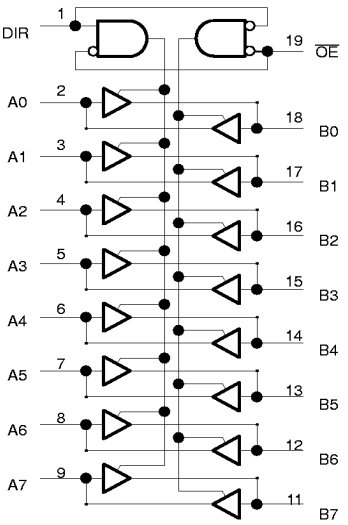
ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
20-Pin Plastic SO	–40°C to +85°C	74AC245 D 74ACT245 D	74AC245 D 74ACT245 D	SOT163-1
20-Pin Plastic SSOP Type II	–40°C to +85°C	74AC245 DB 74ACT245 DB	74AC245 DB 74ACT245 DB	SOT339-1
20-Pin Plastic TSSOP Type I	–40°C to +85°C	74AC245 PW 74ACT245 PW	74AC245PW DH 74ACT245PW DH	SOT360-1

PIN CONFIGURATION



LOGIC SYMBOL



PIN DESCRIPTION

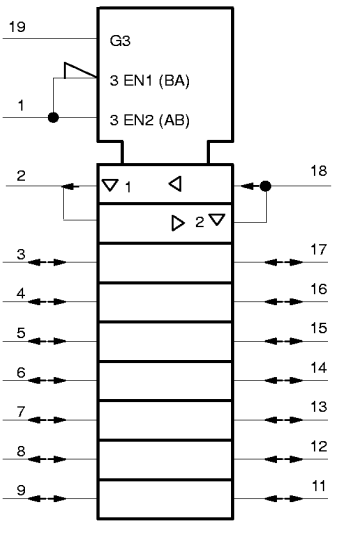
PIN NUMBER	SYMBOL	NAME AND FUNCTION
1	DIR	Direction control input
2, 3, 4, 5, 6, 7, 8, 9	A0 – A7	Data inputs/outputs (A side)
18, 17, 16, 15, 14, 13, 12, 11	B0 – B7	Data inputs/outputs (B side)
19	$\overline{OE}$	Output enable input (active–Low)
10	GND	Ground (0V)
20	V_{CC}	Positive supply voltage

FUNCTION TABLE

INPUTS		INPUTS/OUTPUTS	
$\overline{OE}$n	DIR	An	Bn
L	L	An= Bn	Inputs
L	H	Inputs	Bn =An
H	X	Z	Z

H = High voltage level
L = Low voltage level
X = Don't care
Z = High impedance "Off" state

LOGIC SYMBOL (IEEE/IEC)



RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS		UNIT
		MIN	MAX	
V_{CC}	DC supply voltage for 'AC	2.0	6.0	V
V_{CC}	DC supply voltage for 'ACT	4.5	5.5	V
V_I	DC input voltage range	0	V_{CC}	V
V_O	DC output voltage range	0	V_{CC}	V
T_{amb}	Operating free-air temperature range	–40	+85	°C
$\Delta V/\Delta t$	Minimum input edge rate — AC devices V_{IN} from 30% to 70% of V_{CC} V_{CC} @ 3.3V, 4.5V, 5.5V	125		mV/ns
	— ACT devices V_{IN} from 0.8V to 2.0V V_{CC} @ 4.5V, 5.5V	125		

ABSOLUTE MAXIMUM RATINGS[1]

in accordance with the Absolute Maximum Rating System (IEC134)
Voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V_{CC}	DC supply voltage		–0.5 to +7.0	V
I_{IK}	DC input diode current	V_I = –0.5V	–20	mA
		V_I = V_{CC} + 0.5V	+20	
V_I	DC input voltage		–0.5 to V_{CC} +0.5	V
I_{OK}	DC output diode current	V_O = –0.5V	–20	mA
		V_O = V_{CC} + 0.5V	+20	
V_O	DC output voltage		–0.5 to V_{CC} +0.5	V
I_O	DC output source or sink current		± 50	mA
I_{CC}, I_{GND}	DC V_{CC} or GND current per output		± 50	mA
I_{CC}, I_{GND}	DC V_{CC} or GND current		± 200	mA
T_{stg}	Storage temperature range		–65 to 150	°C
P_{TOT}	Power dissipation per package – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	500 500	mW

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS (74AC245)

Over recommended operating conditions voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	TEST CONDITIONS	V_{CC} (V)	LIMITS			UNIT
				Temp = -40°C to +85°C			
				MIN	TYP[1]	MAX	
V_{IH}	HIGH level Input voltage	V_{OUT} = 0.1V or (V_{CC} – 0.1V)	3.0	2.1	1.5		V
			4.5	3.15	2.25		
			5.5	3.85	2.75		
V_{IL}	LOW level Input voltage	V_{OUT} = 0.1V or (V_{CC} – 0.1V)	3.0		1.5	0.9	V
			4.5		2.25	1.35	
			5.5		2.75	1.65	
V_{OH}	HIGH level output voltage	I_{OUT} = –50 μA	3.0	2.9	2.99		V
			4.5	4.4	4.49		
			5.5	5.4	5.49		
		V_{IN} = V_{IL} or V_{IH}, I_{OH} = –12mA[1]	3.0	2.46			V
		V_{IN} = V_{IL} or V_{IH}, I_{OH} = –24mA[1]	4.5	3.76			
		V_{IN} = V_{IL} or V_{IH}, I_{OH} = –24mA[1]	5.5	4.76			
V_{OL}	LOW level output voltage	I_{OUT} = 50 μA	3.0		0.01	0.1	V
			4.5		0.01	0.1	
			5.5		0.01	0.1	
		V_{IN} = V_{IL} or V_{IH}, I_{OL} = 12mA[1]	3.0			0.44	V
		V_{IN} = V_{IL} or V_{IH}, I_{OL} = 24mA[1]	4.5			0.44	
		V_{IN} = V_{IL} or V_{IH}, I_{OL} = 24mA[1]	5.5			0.44	
I_{IN}	Input leakage current	V_{IN} = V_{CC}, GND	5.5			±1.0	μA
I_{OZ}	3-State output OFF-state current	V_{IN} = V_{IL}, V_{IH} V_{OUT} = V_{CC}, GND	5.5			±2.5	μA
I_{OLD}	Dynamic output current[2]	V_{OLD} = 1.65V max	5.5	75			mA
I_{OHD}	Dynamic output current[2]	V_{OHD} = 3.85V min	5.5			–75	mA
I_{CC}	Quiescent supply current	V_{IN} = V_{CC} or GND	5.5			40	μA

NOTES:

1. All outputs loaded
2. Maximum test duration 2.0 ms; one output loaded at a time

DC ELECTRICAL CHARACTERISTICS (74ACT245)

Over recommended operating conditions voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	TEST CONDITIONS	V_{CC} (V)	LIMITS			UNIT
				Temp = -40°C to +85°C			
				MIN	TYP[1]	MAX	
V_{IH}	HIGH level Input voltage	V_{OUT} = 0.1V or (V_{CC} – 0.1V)	4.5	2.0	1.5		V
			5.5	2.0	1.5		
V_{IL}	LOW level Input voltage	V_{OUT} = 0.1V or (V_{CC} – 0.1V)	4.5		1.5	0.8	V
			5.5		1.5	0.8	
V_{OH}	HIGH level output voltage	I_{OUT} = –50 μA	4.5	4.4	4.49		V
			5.5	5.4	5.49		
		V_{IN} = V_{IL} or V_{IH}, I_{OH} = –24mA[1]	4.5	3.76			V
		V_{IN} = V_{IL} or V_{IH}, I_{OH} = –24mA[1]	5.5	4.76			
V_{OL}	LOW level output voltage	I_{OUT} = 50 μA	4.5		0.01	0.1	V
			5.5		0.01	0.1	
		V_{IN} = V_{IL} or V_{IH}, I_{OL} = 24mA[1]	4.5			0.44	V
		V_{IN} = V_{IL} or V_{IH}, I_{OL} = 24mA[1]	5.5			0.44	
I_{IN}	Input leakage current	V_{IN} = V_{CC}, GND	5.5			±1.0	μA
I_{OZ}	3-State output OFF-state current	V_{IN} = V_{IL}, V_{IH} V_{OUT} = V_{CC}, GND	5.5			±2.5	μA
ΔI_{CC}	Additional quiescent supply current per input pin	V_{IN} = V_{CC} – 2.1V Other inputs at V_{CC} or GND; I_{OUT} = 0	5.5			1.5	mA
I_{OLD}	Dynamic output current[2]	V_{OLD} = 1.65V max	5.5	75			mA
I_{OHD}	Dynamic output current[2]	V_{OHD} = 3.85V min	5.5			–75	mA
I_{CC}	Quiescent supply current	V_{IN} = V_{CC} or GND	5.5			40	μA

NOTES:

1. All outputs loaded
2. Maximum test duration 2.0ms, one output loaded at a time

AC CHARACTERISTICS FOR 74AC245

GND = 0V; $t_R = t_F$ = 2.5ns; C_L = 50pF; R_L = 500Ω; .

SYMBOL	PARAMETER	V_{CC}[1]	LIMITS					UNIT	WAVEFORM
			T_{amb} = +25°C			T_{amb} = −40°C to +85°C			
			MIN	TYP	MAX	MIN	MAX		
t_{PLH}	Propagation delay A_n to B_n; B_n to A_n	3.3 5.0	2.0 1.5	4.3 3.2	8.0 6.0	1.5 1.0	9.0 7.0	ns	1
t_{PHL}	Propagation delay A_n to B_n; B_n to A_n	3.3 5.0	2.0 1.5	4.4 3.4	8.0 6.0	1.5 1.0	9.0 7.0	ns	1
t_{PZH}	3-State output enable time $\overline{OE}$ to A_n; $\overline{OE}$ to B_n;	3.3 5.0	2.0 1.5	6.1 4.2	11.0 8.0	1.5 1.0	12.5 9.0	ns	2
t_{PZL}	3-State output enable time $\overline{OE}$ to A_n; $\overline{OE}$ to B_n;	3.3 5.0	2.0 1.5	6.7 4.6	11.0 8.0	1.5 1.0	12.5 9.0	ns	2
t_{PHZ}	3-State output disable time $\overline{OE}$ to A_n; $\overline{OE}$ to B_n;	3.3 5.0	2.0 1.5	5.7 4.0	10.0 7.5	1.5 1.0	11.5 8.5	ns	2
t_{PLZ}	3-State output disable time $\overline{OE}$ to A_n; $\overline{OE}$ to B_n;	3.3 5.0	2.0 1.5	5.1 3.7	10.0 7.5	1.5 1.0	11.5 8.5	ns	2

NOTE:
1. Voltage range 3.3V is V_{CC} = 3.3V ± 0.3V
   Voltage range 5.0V is V_{CC} = 5.0V ± 0.5V

AC CHARACTERISTICS FOR 74ACT245

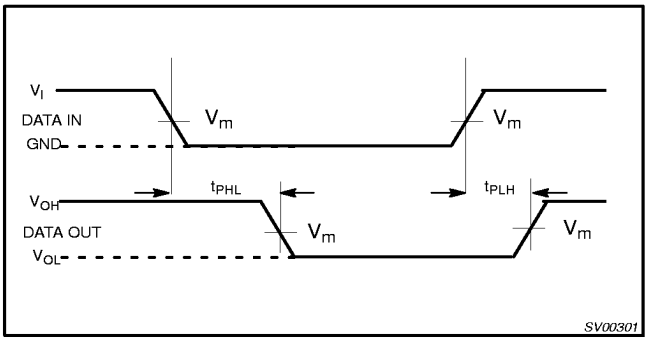
GND = 0V; $t_R = t_F$ = 2.5ns; C_L = 50pF; R_L = 500Ω; .

SYMBOL	PARAMETER	V_{CC}[1]	LIMITS					UNIT	WAVEFORM
			T_{amb} = +25°C			T_{amb} = −40°C to +85°C			
			MIN	TYP	MAX	MIN	MAX		
t_{PLH}	Propagation delay A_n to B_n; B_n to A_n	5.0	2.0	4.3	7.0	1.5	8.0	ns	1
t_{PHL}	Propagation delay A_n to B_n; B_n to A_n	5.0	2.0	4.3	7.0	1.5	8.0	ns	1
t_{PZH}	3-State output enable time $\overline{OE}$ to A_n; $\overline{OE}$ to B_n;	5.0	2.0	6.7	9.5	1.5	11.0	ns	2
t_{PZL}	3-State output enable time $\overline{OE}$ to A_n; $\overline{OE}$ to B_n;	5.0	2.0	7.0	10.5	1.5	12.0	ns	2
t_{PHZ}	3-State output disable time $\overline{OE}$ to A_n; $\overline{OE}$ to B_n;	5.0	2.0	4.9	9.0	1.5	10.0	ns	2
t_{PLZ}	3-State output disable time $\overline{OE}$ to A_n; $\overline{OE}$ to B_n;	5.0	2.0	4.5	9.0	1.5	10.0	ns	2

NOTE:
1. These values are at V_{CC} = 5.0V ± 0.5V

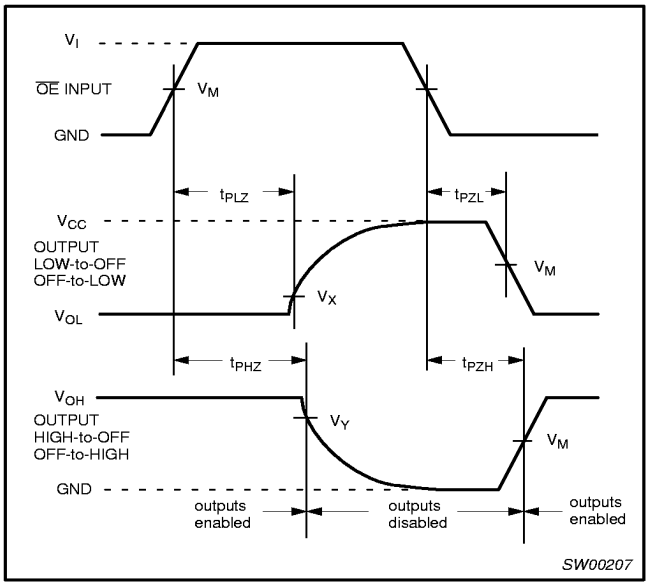
AC WAVEFORMS

V_{OL} and V_{OH} are the typical output voltage drops that occur with the output load.



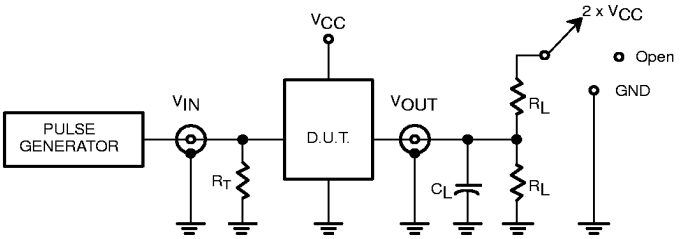
Waveform 1. Input (An or Bn) to Output (Bn or An) Propagation Delays

$V_X = V_{OL} + 0.3V$
$V_Y = V_{OH} - 0.3V$



Waveform 2. 3-State Output Enable and Disable Times

TEST CIRCUIT



Test Circuit for 3-State Outputs

SWITCH POSITION

TEST	SWITCH
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	2 x V_{CC}
t_{PHZ}/t_{PZH}	Open

FAMILY	V_{IN} Input Requirements	V_m Input	V_m Output
AC	GND to V_{CC}	50% V_{CC}	50% V_{CC}
ACT	GND to 3.0V	1.5V	50% V_{CC}

DEFINITIONS

R_L = Load resistor; see AC characteristics for value.

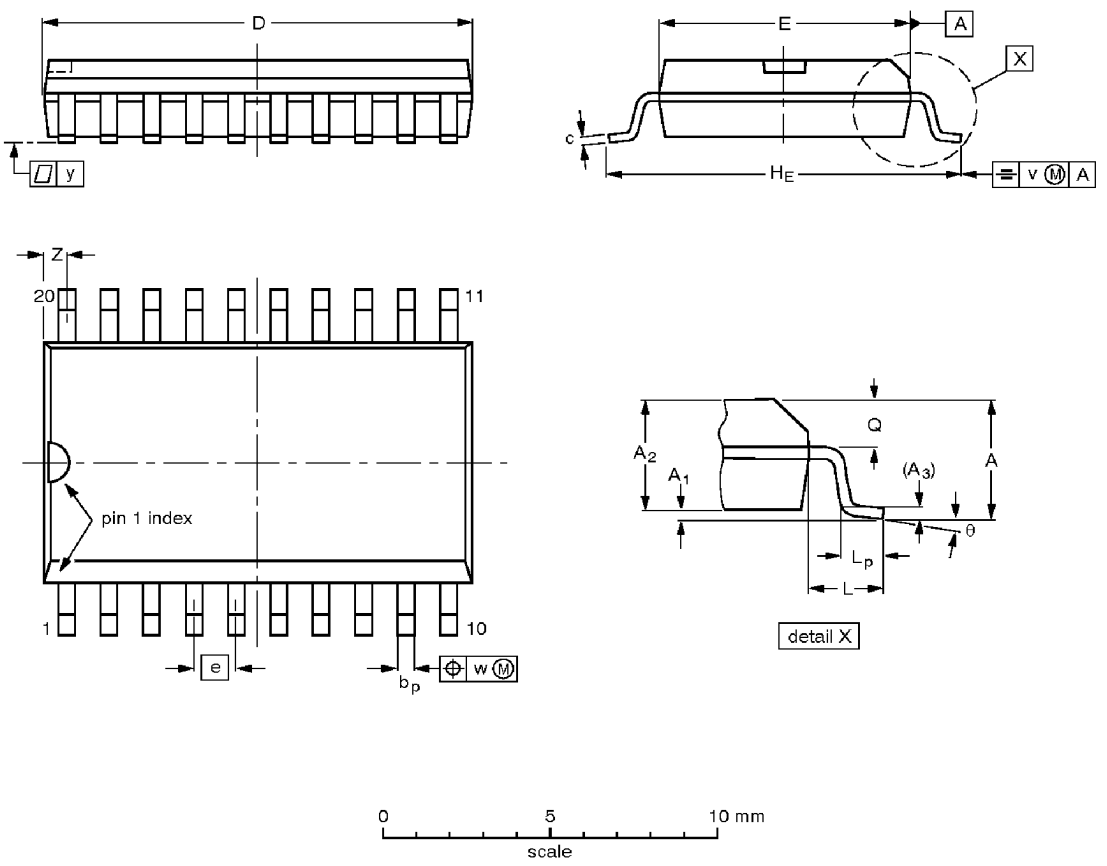
C_L = Load capacitance, see AC characteristics

R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.

SV00451

Waveform 3. Load circuitry for switching times.

SO20: plastic small outline package; 20 leads; body width 7.5 mm **SOT163-1**



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

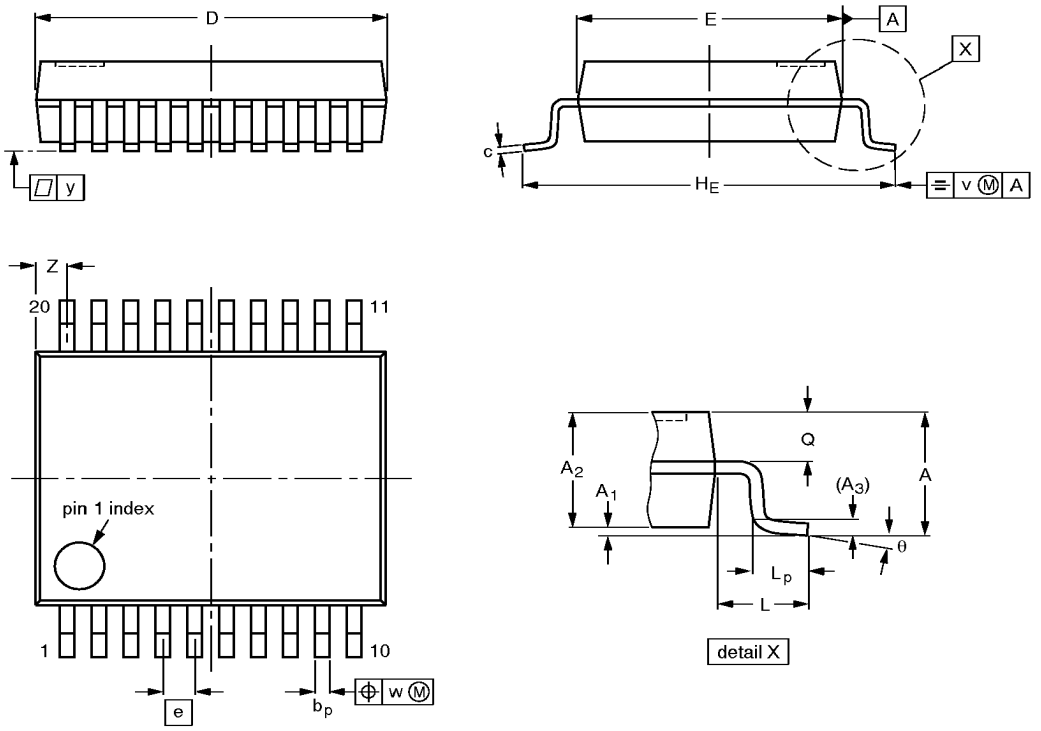
UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	H_E	L	L_p	Q	v	w	y	$Z^{(1)}$	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8^o 0^o
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.42 0.39	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	

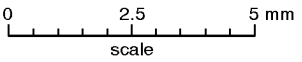
Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT163-1	075E04	MS-013AC				~~92-11-17~~ 95-01-24

SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm **SOT339-1**





DIMENSIONS (mm are the original dimensions)

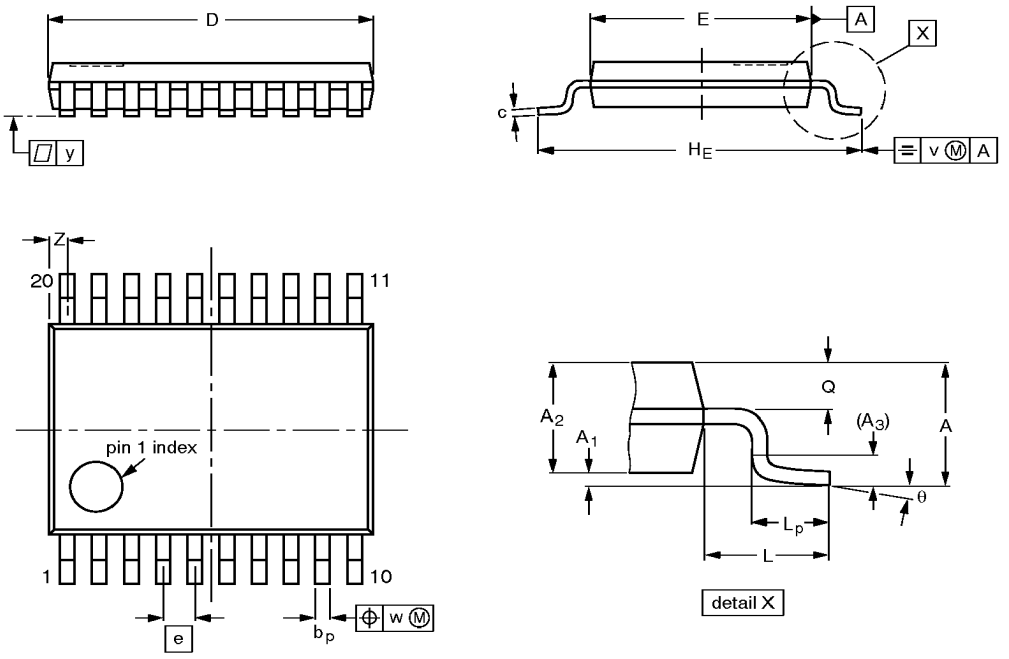
UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	H_E	L	L_p	Q	v	w	y	$Z^{(1)}$	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

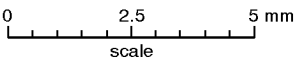
Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT339-1		MO-150AE				~~93-09-08~~ 95-02-04

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm **SOT360-1**





DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	D (1)	E (2)	e	H_E	L	L_p	Q	v	w	y	Z (1)	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT360-1		MO-153AC				~~93-06-16~~ 95-02-04